

# **PS Module Assembly Scheme**

Daniele Pasciuto, University of Pisa, Italy

Supervisor: Andreas Mussgiller

September 9, 2014

## Abstract

In this report a design study for an assembly system for Pixel Strip (PS) Modules is presented. The modules will be part of the CMS Tracker for HL-LHC. The purpose of this study is to figure out what are the individual steps in the assembly procedure, to realize a possible semi-automatic system for assembly and to understand the machine requirements in order to find a valid manufacturing supplier.

## Contents

- 1. HL-CMS Tracker description
- 2. PS Module description
- 3. Mounting system design3.1. PS Module assembly description3.2. Prototype mounting system
- 4. Preliminary technical drawings

#### 1. HL-CMS Tracker description



0

In 2024 the CMS Tracker will be upgraded in order to improve its characteristics. The most important features will be:

- Higher granularity more than 200 collisions per bunch crossing are expected and therefore modules will have shorter strips in order to keep a low occupancythat. It means that there will be much more data per event, so the need to be selective is really important.
- Improve of tracking performance the strip pitch will be lower in order to increase resolution for high momentum particles and there will be a reduction of the amount of material, to improve the resolution for low momentum particles.
- Higher radiation tolerance it has to tolerate 3000 fb<sup>-1</sup> so sensors will be made of radiation hard materials. That has to been cooled to -20°C.
- Using Tracker information in the level 1 trigger with higher luminosity the event data rate will increase. Although the level-1 trigger transfer data will be increase to 750Hz, to not increase theresholds (which would reduce physics performance), there is the need to include tracker information in the level-1 trigger decision (Fig.3, Fig.4).



The tracker will be composed by two different kind of modules: Strip-Strip (2S) and Pixel-Strip (PS) Modules (Fig. 2). As their names say, the first one are made by two strip sensors, and they will be placed in the outer part of the tracker; and the second ones by one pixel sensor and one strip sensor, and they'll be in the inner part.

The main features of these modules is that they are able to distinguish high momentum particles from the low momentum ones (comparing signals from the two sensors) and so they can select which signals are consistents and which ones're not. The need of this behaviour is that with high luminosity the amount of tracks will be too huge, and the signal transmission rate isn't able to collect all the datas it would have otherwise



Fig. 4: Future Tracker working scheme

#### 2. PS Module description



The main feature of the PS Module (Fig.5) is its capability to perform an on-module momentum measurement. It is able to do this thanks to the presence of the two sensors. Indeed it is able to understand which signals are linked to the passage of a high momentum particle through it. When a particle is surrounded by a magnetic field, it bends its trajectory more and more the less its momentum is. Bending of particles in magnetic field results in a sizeable shift already at short distances. So each particle cross the two sensors, and if it's a high momentum particle it will cross the sensors as shown in Fig.6 (the yellow marked trajectory). Otherwise, if the particle is a low momentum one, it will bend more its trajectory and so it will cross the sensor in two points that are not one over the other (Fig.6-right). Therefore, it generates two different signals, an ASIC present on the module compares these signals, and it can understand which kind of particle has generated them. In this way a cut on the momentum is used to generate trigger signals for high momentum tracks and it can trigger at 40MHz without losing important events.





Fig. 7: PS Module exploded view

The main parts the module is composed are (Fig. 7):

- the carbon fiber base plate (1), which supports the module;
- the pixel sensor (3) with ASICs on the top, in order to amplify signals from the sensor and compare them with the strip signals in order to achieve the particle selection mentioned above;
- the strip sensor (7) that is spaced to the pixel sensor by two spacers;
- two hybrid (9, 10) that are connected to the pixel and strip sensor by bond wires (17, 18). They have ASICs on the top to amplify strip signals and other to codify signals to be sent to the opto board;
- the opto board (16) has the duty of transmitting data via optical fibers;
- the power board (12) for DC-DC conversion.

All this components are joined by glue, in order to avoid heavy mass fasteners (like screws, nuts and other similar).

### 3. Mounting system design

In order to figure out the most delicate steps of assembly, understand possible design problems and to understand the possibility to commit production to factories, a possible scheme for semi-automated assembly has been designed.

![](_page_6_Picture_2.jpeg)

Fig. 8: PS Module

#### 3.1. PS Module assembly description

The most important tasks for assembly are:

- high precision in positioning between the strip and pixel sensors and the carbon fiber base plate: two points that should have to stay one over the other one cannot be misaligned more than 15  $\mu$ m. Moreover, the two sensors should be also parallel one to each other. This because their misalignment cannot be corrected offline (in order to use less material on the module) and it's necessary to perform the onmodule momentum measurement (see Fig.6). Therefore, this precision has to be guaranteed by the production system.
- other parts have to be quite precise in positioning (less than 100 μm);
- the whole process has to be repeatable because the future tracker will consist of around seven thousand PS Modules.

All the parts are completely already processed and some of those are pre-assembled (like the hybrid modules).

In order to reach the requirements we decided to differentiate the process in three different phases:

- in the first one there will be all the operations requiring high precision. A CNC machine will make all of that. During this operation the pixel and the strip sensor will be mounted;
- in the second one there will be all the operation requiring less precision. An operator will make these steps. In this way the assembly will be faster (because it will happen in parallel) and probably less expensive;

• in the last part all the bond wire connections will be made. This step requires dedicated machines.

#### **3.2. Prototypal Mounting Design**

Shown below there is a possible PS Module assembly scheme. Some equipment needed for this has been designed just for this purpose, others are commercial equipments.

The frame for all the machine-made operation is the assembly plate (Fig. 9). It's an aluminum plate with two glass pegs for references (the using of the glass material will be explained better further) and a vacuum system to fix the module during assembly operations by applying a uniform pressure that avoid to bend or tilt it.

![](_page_7_Figure_4.jpeg)

Fig. 9: The assembly plate

There are also other reference pegs (on the sides) but they need in the further operations.

The first step is to place the carbon fiber base plate to the assembly plate (Fig. 10). The two glass pegs slot in the holes of the carbon fiber. Now turning on the suction pump (not shown in the pictures), the carbon fiber is fixed to the assembly plate.

![](_page_8_Picture_0.jpeg)

Fig. 10: The assembly plate with the carbon fiber base plate

After that the pixel sensor (with ASICs) has to be glued. The idea is to have a dispenser for glue automatic on the robotic arm of the machine. This arm has to have also a visioning system and a gripping end-effector (a suction kind). Indeed the pixel assembly has markers on its top and the glass pins have a cross engraved on their top for an easy reading (Fig. 11). So after their scanning the robotic arm can pick and place the sensor in the right position. Indeed, thanks to the visioning system, the robotic arm can check marks and making sure of the precision required has been achieved.

![](_page_8_Picture_3.jpeg)

Fig. 11: Glass pin and sensor reference marker

The problem at this time is how to hold the pixel sensor during glue curing. This process can last more than one hour and the use of robotic arm for this purpose is a waste of money (machine time is the most expensive part). We cannot use also ordinary clamps, because there is no security about the amount of pressure and the possibility of pixel sensor shifting during curing. Indeed using ordinary clamps there is the possibility they apply shear forces. Because curing lasts a lot of time also little shear forces are dangerous because they can shift components too much. For these reasons, we decided to use four inflatable clamps (Pic.12).

![](_page_9_Picture_0.jpeg)

Fig. 12: Inflatable clamps for pixel assembly

These clamps are fixed on the assembly plate by magnets (their size has to be set after we know how much pressure the clamp has to apply) and they are easy to put in position thanks to references pins. They have a rubber membrane on the bottom and a fastener to join pressure pipes. When they are inflated, the membrane expands until it has contact with the pixel sensor. In this way we can be sure that the pressure made by the clamp is homogenous, and it can be regulated by inflating pressure, and that will not be shear forces. This operation is made by hand. So while the robot holds the pixel sensor in position, the operator mounts two of the clamps (the external ones) and inflates them. Only at this point, the robotic arm release the sensor letting the operator to mount the other ones. The suction gripper to use for this has to be sized to do this work.

After mounting all the clamps the assembly plate can be removed from the machine for curing of the glue. In the meanwhile the machine can start another production step with another set of tooling.

The next step is positioning of the strip sensor. To assure that the two spacers are glued very parallel to the sensor (this should be done for mechanical reasons, otherwise the strip sensor can crack when we apply pressure during glue curing), they are glued in a dedicated step before. The strip sensor lays on the ground and the two spacers are glued on it.

After this, the way to place the strip sensor over the pixel sensor is similar to the previous step. The clamps we use are similar to the previous ones (Fig. 13); the only differences are they apply pressure just over the spacers (in order to do not crack the sensor that have any support in the middle) and they have the reference holes in different places.

![](_page_10_Picture_0.jpeg)

Fig. 13: Inflatable clamps for strip assembly

Now the high precision steps are complete and there is no more need to use the assembly plate. So the module is shifted to another aluminum baseplate (Fig. 14). This is simpler than the previous one. It has some fixed toggle clamps (Fig. 15) and only references pins. The smaller pins are for positioning of the module on the frame, while the bigger ones are for gluing template.

![](_page_10_Picture_3.jpeg)

Fig. 14: The clamping assembly plate

The particularities of the clamps are that they are very easy to use and there's the possibility of setting pressure. Indeed they have a screw on the top, which can shift inside its slot, and a spring, which pull the screw on the bottom. So its sensitivity for errors is very low. And if they are mounted over inclined steps they have the possibility to apply also shear forces. At this time this is useful features because in the next steps positioning is made doing edges reach mechanic stops. So to be sure that during curing any shift happens, it's better if there's some shear force that push over that.

![](_page_11_Picture_0.jpeg)

Fig. 15: Toggle clamps

The first step is to glue the two hybrid modules (Fig. 16). It's done putting a template (the red one) fitting into the pegs. This template is hold in position by two beams that wedge them in the template (the green one).

So the operator has to put in position the template, to lock it with the beam, to apply glue, to place hybrids and to close the four little toggle clamps. After glue has cured he has to make the reverse process. We choose this solution because it's better don't have the possibility to hit these components when the template is removed. In this way they slide away (after removing the locking beam).

In order to not damage the hybrids, the clamps don't push directly over them, but there are covers that are shaped to push them in not delicate points. The shape of them has to be defined after the pieces have their final configuration.

After, the operator has to make the same process with the power board and the opto board (Fig. 17). These templates are simply thrown away from their pins after used them (there is any locking bar).

These operations can be done also in the same sub phase because they are independent one to each other. In this way they can cure together.

![](_page_12_Picture_0.jpeg)

Fig. 16: Hybrid mounting

The Last operation is creating electrical connection between all the parts, and it's done by a dedicated machine. There are any particular advertising in that. There is only the need to pose the module upside down when wire bond connections are done to the pixel sensor. A possibility is to create a Teflon step that fit on the strip sensor, and all the module lays over it during this operation.

![](_page_12_Picture_3.jpeg)

Fig. 17: Power and opto boards mounting

## 4. Preliminary technical drawings

Shown below there are the technical drawings about home-made equipment.

These components, as said before, are not definitive. They are only an outline for a further complete design. Also followings are not complete for production and installation.

![](_page_14_Figure_0.jpeg)

![](_page_14_Figure_1.jpeg)

Re	f.	Quantity							
1		Assembly Plate	1						
2		Assembly Plate	Assembly Plate Lower						
3		Glass peg		2					
4		ISO 4762 M4 x	10 10N	10					
5		Dowel Pin 4x 2338 m6	1 6 ISO	8					
6		Magnet		16					
7		Seal		3					
P EI	rs.für /	REPLACES	Ers.durch / RE	PLACED BY					
	Irkstoff	A3							
T	itel / T	ITLE							
	Automatic Assembly plate								
De	kument-	Nr. / DOCUMENT NO.		Blatt 1 SHEET 1					
				VON 1					
Za	chng.−ID RAW <b>. −</b> ID	Rev REV	Ver. VER.	Status STATUS					

![](_page_15_Figure_0.jpeg)

![](_page_16_Figure_0.jpeg)

2	Ers.für / REPLACES	Ers.durch / REPLAC	ed by
	Werkstoff / NATERIAL Aluminum	1	Format/SIZE A3
	Assembly Plate Lov	wer	
	Dokument-Nr, / DOCUMENT NO,		Blatt 1 SHEET 1
	3		Von 1 OF 1
	ZchngID Rev DRAW, -ID REV	Ver. Stat	us US

![](_page_17_Figure_0.jpeg)

![](_page_18_Figure_0.jpeg)

![](_page_19_Figure_0.jpeg)

	Ref	Nam	е	Quantty			
v	1	Operator Plate		1			
•	2	GN 820-455-M		4			
	3	GN 820-455-M k	GN 820-455-M big				
	4	Dowel Pin 4x16 m6	ISO 2338		4		
	5	Glass peg			2		
	6	ISO 4762 M4 x 1	6 16N		24		
	7	Clamps step b	pig		2		
	8	Clamp step lit	tle	4			
	9	Holder steps		1			
P	Ers.für	ACED BY	ſ	٦			
	Nerkstof	Werkstoff / NATERIAL					
T	Titel / TITLE						
_	Titel /	TITLE				٦	
	Titel /	TITLE	( Plata			1	
	Ope	title rator Assembly	/ Plate				
	Ope	title erator Assembly	/ Plate				
	Dokument	TITLE Prator Assembly	/ Plate	Blo	ott 1		
	Dokument	TITLE erator Assembly -Nr. / DOCUMENT NO.	/ Plate	Bio	Dit 1 ET 1		
	Titel / Ope Dokument 6 Zchng	TITLE Prator Assembly -Nr. / DOCUMENT NO.	/ Plate	Bio SHE Von otus	ett 1 ET 1		

![](_page_20_Figure_0.jpeg)

![](_page_21_Figure_0.jpeg)

![](_page_21_Figure_1.jpeg)

Projekt / PROJECT HL-LHC	Arbeitspaket / WORKPACKAGE PS Module Assembly system					Gruppe / GROU CMS
Gewicht / WEIGHT	Halbzeug	/ Semifinished Pro	DUCT			8
Allg. Toleranzen / GENERAL TOLERANCES Tolerierungsarundsatz /	90 2768  90 13920		Maßs 2:	itab / SCALI :1	E	
FUNDAMENTAL Tolerancing Principle	190 8015	Toleranzklasse / TOLERANCE CLASS	Teil PART	-ID -ID Datum/DATE		Name / NAME
Oberflächenkenngrößen / SURFACE TEXTURE	/ ISO 1302 4287, 4288	mH	Gez. CRE.	09/09/14	Da	niele Pasciuto
0 DESY. DESY behält sich ISO 16016 beochten. Für R Tel. +49-40-8998-3675, 0 DESY. ALL RIGHTS RESERV ISO 16016. FOR FURTHER EN TEL. +49-40-8998-3675.	vor, Schulzvernerk tte on -TT- wenden, D TO PROTECTION NOTICE SE CONTACT -TT-	Gepr. REV. Frei. REL. Gen. APR.				

![](_page_21_Figure_4.jpeg)

# It needs 2 Dowel Pin 3x10 ISO 2338 filling the holes Not marked chanfers are 1x45°

Ρ	Ers.für / REPLACES	Ers.durch / REPLACE	D BY
	Werkstoff / NATERIAL Aluminum		Format/SIZE A3
	Titel / TITLE Hybrid template do	own	
	Dokument-Nr. / DOCUMENT NO. 8		Blatt 1 SHEET 1 Von 1 OF 1
	DRAW ID REV.	VER. Statu	s

![](_page_22_Figure_0.jpeg)

![](_page_22_Figure_1.jpeg)

Projekt / PROJECT HL-LHC	Arbeitspaket / WORKPACKAGE PS Module Assembly system					Gruppe / GROU CMS	JP
Gewicht / WEIGHT	Halbzeug / SEMIFINISHED PRODUCT						
Alig. Toleranzen / GENERAL TOLERANCES Tolerierungsarundsatz	S0 2768  S0 13920		Maßs 2:	tab / SCALI 1	E		
FUNDAMENTAL TOLERANCING PRINCIPLE	/ ISO 8015	Toleranzklasse / TOLERANCE CLASS	Teil PART	- ID - ID Datum/DATE		Name / NAME	
SURFACE TEXTURE	4287, 4288	mH	Ĝez. CRE,	09/09/14	Da	niele Pasciuto	
© DESY. DESY behält sich alle Rechte vor. Schulzvernerk ISO 16016 beochten. Für Rückfragen bitte an -TT- wenden, Tel. +49-40-8998-3675.			Gepr. REV. Frei				_
0 DEST. ALL RIGHTS RESERV ISO 16016. FOR FURTHER EX TEL. +49-40-8998-3675.	DÉSY, ALL RIGHTS RÉSERVED. PREFERRED TO PROTECTION NOTICE SO 16016. FOR FURTHER ENQUIRIES PLEASE CONTACT -TT- IEL. +49-40-8998-3675.						_

![](_page_22_Figure_5.jpeg)

5

## Section K-K

## It needs 2 Dowel Pin 3x10 ISO 2338 filling the holes Not marked chanfers are 1x45°

2	Ers.für / REPLACES	Ers.durch / REPLACE	D BY
	Werkstoff / NATERIAL Aluminum		Format/SIZ A3
	Hybrid template up	D	
	Dokument-Nr, / DOCUMENT NO,		Blatt 1 SHEET 1
	9		von 1 0F 1
	ZchngID Rev. DRAWID REV.	Ver. Statu VER. STATU	s

![](_page_23_Figure_0.jpeg)

![](_page_23_Figure_1.jpeg)

![](_page_23_Picture_2.jpeg)

Projekt / PROJECT Arbeitspaket / WORKPACKAGE Gruppe / GRO   HL-LHC PS Module Assembly system CMS   Gewicht / WEIGHT Halbzeug / SEMIFINISHED PRODUCT Image: Semification of the system   Alig. Toleranzen / GENERAL TOLERANCES ISO 2768 Image: Semification of the system							
Gewicht / WEIGHT Halbzeug / SEMIFINISHED PRODUCT   Alig. Toleranzen / GENERAL TOLERANCES ISO 2768 ISO 13920	Projekt / PROJECT HL-LHC	Arbeitspa PS Ma	Arbeitspaket / WORKPACKAGE PS Module Assembly system				Gruppe / GROU CMS
Allg. Toleranzen / ISO 2768 GENERAL TOLERANCES ISO 13920	Gewicht / WEIGHT	Halbzeug	/ SEMIFINISHED PRO	DUCT			8
	Alig. Toleranzen / GENERAL TOLERANCES	S0 2768  S0 13920	$\bigcirc $	Maßs 2:	itab / SCALI : 1	E	
FUNDAMENTAL ISO 8015 TOLERANCING PRINCIPLE ISO 8015 TOLERANCE CLASS	FUNDAWENTAL TOLERANCING PRINCIPLE	150 8015	30 8015 Toleranzklasse / TOLERANCE CLASS		- ID - ID		
/hes/lisebases/ites / ISO (1702)			700		Dotum/DATE		Name / NAME
SURFACE TEXTURE 4287, 4288 Gez. 09/09/14 Daniele Pasciuto	SURFACE TEXTURE	4287, 4288	mm	Ĝez. CRE,	09/09/14	Da	niele Pasciuto
© DESY, DESY behält sich alls Rechts vor. Schutzvermerk Gepr. ISO 16016 beachten. Für Rückfragen bitte an -TT- wenden, REV.	O DESY, DESY behölt sich ISO 16016 beochten, Für	alle Rechte Rückfragen bi	vor, Schulzvernerk tte an -TT- wenden,	Gepr. REV.			
Tel. +49-40-8938-3675. © DESY. ALL RIGHTS RESERVED. PREFERRED TO PROTECTION NOTICE REL.	Tel. +49-40-8998-3675, o DESY. ALL RIGHTS RESER	D TO PROTECTION NOTICE	Frei. REL.				
ISO 16016. FOR FURTHER ENQUIRIES PLEASE CONTACT -TT- TEL. ++9-40-8998-3675. APR.	ISO 16016, FOR FURTHER E TEL, ++9-40-8998-3675,	SE CONTACT -TT-	Gen. APR.				

2	Ers.für / REPLACES	/ REPLACES Ers.durch / REPLACED						
	Werkstoff / NATERIAL		Format/	SIZE				
	Aluminum		A3					
	Titel / TITLE							
	Livbrid tomplate helder up							
_								
	Dokument-Nr, / DOCUMENT NO,		Blatt SHEET	1				
	10		von OF	1				
	ZchngID Rev. DRAWID REV.	Ver. Statu VER. STATU	S					

![](_page_24_Figure_0.jpeg)

![](_page_24_Figure_1.jpeg)

![](_page_24_Figure_2.jpeg)

Projekt / PROJECT Arb HL-LHC P	Arbeitspoket / WORKPACKAGE PS Module Assembly system					Gruppe / GROUP CMS
Gewicht / WEIGHT Hal	bzeug / !	SEMIFINISHED PRO	DUCT			8
Alig. Toleranzen / ISO GENERAL TOLERANCES ISO	) 2768 ) 13920 -	$\mathbb{P}$	Maßs 2:	tab / SCALI :1	E	
FUNDAMENTAL ISU	0 8015 T	oleranzklasse / OLERANCE CLASS	Teil PART	- ID - ID		
Cherflächenkennerölen / K	50 1302			Dotum/DATE		Name / NAME
SURFACE TEXTURE 428	7, 4288	111	Gez. CRE,	09/09/14	Da	niele Pasciuto
O DESY, DESY behält sich alle ISO 16016 beachten. Für Rückfi	Rechte vor ragen bitte	, Schulzvernerk on -IT- wenden,	Gepr. REV,			
Tel, +49-40-8998-3675, o desy, all rights reserved, preferred to protection notice			Frei. REL.			
ISO 16016. FOR FURTHER ENQUIR TEL. +49-40-8998-3675.	ISO 16016. FOR FURTHER ENQUIRIES PLEASE CONTACT TEL. +49-40-8998-3675.					

2	Ers.für ∕ REPLACES	für / REPLACES Ers.durch / REPLACED					
	Werkstoff / NATERIAL			Format/	SIZE		
	Aluminum			A3			
	Titel / TITLE						
	Hybrit template holder down						
	Dokument-Nr, / DOCUMENT NO,			Blatt	1		
	11			von OF	1		
	ZchngID Rev. DRAWID REV.	Ver. VER.	Statu	s S			

![](_page_25_Figure_0.jpeg)

![](_page_26_Figure_0.jpeg)

![](_page_26_Figure_1.jpeg)

![](_page_26_Picture_2.jpeg)

Projekt / PROJECT HL-LHC	Arbeitspaket / WORKPACKAGE PS Module Assembly system					Gruppe / GROU CMS	UP
Gewicht / WEIGHT	Halbzeug / SEMIFINISHED PRODUCT						
Allg. Toleranzen / GENERAL TOLERANCES	ISO 2768 ISO 13920	$\bigcirc $	Maßs 2:	itab / SCALI : 1	Ε		
FUNDAMENTAL TOLERANCING PRINCIPLE	ISO 8015	30 8015 Toleranzklasse / TOLERANCE CLASS		- ID - ID			
(has (15) has been as 24 as	/ 160. (200			Dotum/DATE		Name / NAME	
SURFACE TEXTURE	4287, 4288	mm	Ĝez. CRE,	09/09/14	Da	niele Pasciuto	,
© DESY, DESY behält sich LSO 16016 beochten Für B	alle Rechte Vickfragen hi	vor, Schulzvernerk tie nn -II- wenden,	Gepr. REV				
Tel, +49-40-8998-3675, o DESY, ALL RIGHTS RESERV	Tel. +49-40-8998-3675. n DESY ALL PLOYER DESERVED DESERVED TO DESTECTION MOTION						_
ISO 16016. FOR FURTHER ENQUIRIES PLEAU TEL. +49-40-8998-3675.		SE CONTACT -TT-	Gen. APR.				_

## Not marked chanfers are 1x45°

P	Ers.für / REPLACES	Er	s.durch / R	EPLACE	D BY	
	Werkstoff / NATERIAL Aluminum	1			Format/ A3	SIZE
	Titel / TITLE	- 1 - 1	_			
_	Opto board temp	Diat	e			
	Dokument-Nr, / DOCUMENT NO,				Blatt SHEET	1
	13				von OF	1
	ZchngID Re DRAWID RE	ev. EV.	Ver. VER.	Statu STATU	s S	

![](_page_27_Figure_0.jpeg)

![](_page_27_Figure_1.jpeg)

Projekt / PROJECT Arbeitsp HL-LHC PS M	Arbeitspaket / WORKPACKAGE PS Module Assembly system				Gruppe / GROUF CMS
Gewicht / WEIGHT Halbzeug	/ SEMIFINISHED PRO	DUCT			8
Alig. Toleranzen / ISO 2768 GENERAL TOLERANCES ISO 13920 Talasiannananananan	$  \bigcirc $	Maßs 2:	itab / SCALI : ]	E	
FUNDAMENTAL ISO 8015 TOLERANCING PRINCIPLE	Toleranzklasse / TOLERANCE CLASS	Teil-ID PART-ID			
Oberflöchenkennarößen 7 – ISO 1302	mH		Dotum/DATE		Nome / NAME
SURFACE TEXTURE 4287, 4288	1101	Gez. CRE.	09/09/14	Da	niele Pasciuto
© DESY, DESY behölt sich alle Rechte ISO 16016 beochten, Für Rückfragen b	vor, Schulzvernerk itte on -TT- wenden,	Gepr. REV.			
Tel, +49-40-8998-3675, o desy, all rights reserved, preferr	ED TO PROTECTION NOTICE	Frei. RFI			
ISO 16016. FOR FURTHER ENQUIRIES PLE TEL. +49-40-8998-3675.	ASE CONTACT -TT-	Gen. APR.			

)	Ers.für / REPLACES	Ers.durch / REPLACE	D BY
	Werkstoff / NATERIAL Aluminum		Format/SIZE A3
	Titel / TITLE		
	Opto boart holder		
	Døkument-Nr, / DOCUMENT NO,		Blott 1 SHEET 1
	14		von 1 0F
	ZchngID Rev. DRAWID REV.	Ver. Stotu VER. STATU	s S

The shape cutted away has to be defined after having precise drawings of the opto board

![](_page_28_Figure_0.jpeg)

![](_page_28_Figure_1.jpeg)

![](_page_28_Figure_2.jpeg)

![](_page_28_Picture_3.jpeg)

Projekt / PROJECT HL-LHC	Arbeitspaket / WORKPACKAGE PS Module Assembly system				Gruppe / GROU CMS	UP	
Gewicht / WEIGHT	Halbzeug / SEMIFINISHED PRODUCT						
Alig. Toleranzen / GENERAL TOLERANCES	$\bigcirc $	Maßstab / SCALE 2:1					
FUNDAMENTAL TOLERANCING PRINCIPLE	Í ISO 8015	Toleranzklasse /	Taleranzklasse / Teil-ID Taleranzklasse / PART-ID				
Char ( Debacherrar Stee	/ 160 1300			Dotum/DATE		Name / NAME	
SURFACE TEXTURE	4287, 4288		Gez. CRE,	09/09/14	Da	niele Pasciuto	)
O DESY, DESY behält sich ISO 16016 beochten, Für F	© DESY, DESY behält sich alle Rechte v ISO 16016 beochten. Für Rückfragen bil		Gepr. REV.				
Tel, +49-40-8998-3675, o desy, all rights reserved, preferred		D TO PROTECTION NOTICE	Frei. RFL				
ISO 16016. FOR FURTHER EN TEL. +49-40-8998-3675.	SE CONTACT -TT-	Gen. APR.					

P	P Ers.für / REPLACES Ers.durch / REPLACED BY				
	Werkstoff / NATERIAL			Format/	SIZE
	Aluminum			A3	
	Titel / TITLE				
	Power board temp	olate			
	Dokument-Nr, / DOCUMENT NO,			Blatt SHEET	1
	15			von OF	1
	ZchngID Rev. DRAWID REV.	Ver. VER.	Statu: STATU:	s	

![](_page_29_Figure_0.jpeg)

The shape cutted away has to be defined after having precise drawings of the power board

Р	Ers.für / REPLACES	Ers.durch / REPLACE	D BY
	Werkstoff / NATERIAL Aluminum		Format/SIZE A3
	Power board holde	er	
	Dokument-Nr. / DOCUMENT NO.		Blott 1 SHEET 1
	16		von 1 0F 1
	ZchngID Rev. DRAWID REV.	Ver. Statu VER. STATU	s

![](_page_30_Figure_0.jpeg)

![](_page_30_Figure_1.jpeg)

	0	
	$\bigcirc$	$\bigcirc$
K		

Projekt / PROJECT Arbei HL-LHC PS	Arbeitspaket / WORKPACKAGE PS Module Assembly system				
Gewicht / WEIGHT Halbz	Halbzeug / SEMIFINISHED PRODUCT				
Alig. Toleranzen / ISO 2 GENERAL TOLERANCES ISO 1.		Maßs 2:	itab / SCALI : ]	E	
FUNDAMENTAL ISO 8 TOLERANCING PRINCIPLE	115 Toleranzklasse / TOLERANCE CLASS	Teil-ID PART-ID			
Oberflächenkenngrößen / ISO / SURFACE TEXTURE 4287,	1302 mH	Gez. CRE.	09/09/14	Da	niele Pasciuto
O DESY. DESY behält sich alle Rev ISO 16016 beochten. Für Rückfrag Tel. +49-40-8938-3675. O DESY. ALL RIGHTS RESERVED. PREI ISO 16016. FÜR FURTHER ENQUIRIES TEL. +49-40-8998-3675.	hte vor. Schulzvernerk en bitte on -TT- wenden, TERRED TO PROTECTION NOTICE PLEASE CONTACT -TT-	Gepr. REV. Frei. REL. Gen. APR.			

2	Ers.für / REPLACES	Ers.durch / REPLACE	D BY	
	Werkstoff / NATERIAL Aluminum		Format/ A3	SIZE
	Clamp step big			
	Dokument-Nr, / DOCUMENT NO,		Blatt SHEET	1
	17		von OF	1
	ZchngID Rev. DRAWID REV.	Ver. Statu VER. STATU	IS IS	

![](_page_31_Figure_0.jpeg)

![](_page_31_Figure_1.jpeg)

![](_page_31_Figure_2.jpeg)

Projekt / PROJECT HL-LHC	Arbeitspaket / WORKPACKAGE PS Module Assembly system					Gruppe / GROUP CMS
Gewicht / WEIGHT	Halbzeug / SEMIFINISHED PRODUCT				×	
Alig. Toleranzen / GENERAL TOLERANCES	$\bigcirc $	Maßstab / SCALE 2:1				
FUNDAMENTAL TOLERANCING PRINCIPLE	Í ISO 8015	Taleranzklasse / Teil-ID Taleranzklasse / PART-ID				
Charf Lächaskassarölas	/ 150 1302			Dotum/DATE		Nome / NAME
SURFACE TEXTURE	4287, 4288		Gez. CRE,	09/09/14	Daniele Pasciuto	
O DESY. DESY behölt sich ISO 16016 beochten. Für f	alle Rechte Rückfragen bi	vor, Schulzvernerk tte on -TT- wenden,	Gepr. REV.			
Tel. +49-40-8998-3675. • DESY. ALL RIGHTS RESERV	Tel. +49-40-8998-3675. © DESY. ALL RIGHTS RESERVED. PREFERRED TO PROTECTION NOTICE ISO 16016. FOR FURTHER ENQUIRIES PLEASE CONTACT -TT- TEL. +49-40-8998-3675.					
ISO 16016. FOR FURTHER EX TEL. +49-40-8998-3675.						

2	Ers.für ∕ REPLACES	Ers.durch / RE	PLACE	) BY	
	Werkstoff / NATERIAL Aluminum			Format/ A3	SIZE
	Titel / TITLE				
	Clamp step little				
	Dokument-Nr, / DOCUMENT NO,			Blatt SHEET	1
	18			von OF	1
	ZchngID Rev. DRAWID REV.	Ver. VER.	Status STATUS		

![](_page_32_Figure_0.jpeg)

)	Ers.für / REPLACES	Ers.durch / REPLACE	D BY				
	Werkstoff / NATERIAL		Format/SIZE A3				
	Titel / TITLE Exploded view high precision operations						
	Dokument-Nr, / DOCUMENT NO, 19		Blatt SHEET 1 Von 1				
	ZchngID Rev. DRAWID REV.	Ver. Statu VER. STATU	s S				

![](_page_33_Picture_0.jpeg)

P	Ers.für / REPLACES	REPLACES Ers.durch / REPLACED BY	
	Werkstoff / NATERIAL		Format/SIZE A3
	Exploded view low precision operations		
	Dokument-Nr. / DOCUMENT NO.		Blatt 1 SHEET 1
	20		Von 1 OF 1
	ZchngID Rev. DRAWID REV.	Ver. Statu VER. STATU	s S